



S1A/B - S1M/B

1.0A SURFACE MOUNT GLASS PASSIVATED RECTIFIER

Features

- Glass Passivated Die Construction for High Reliability
- Surge Overload Rating to 30A Peak
- Ideally Suited for Automated Assembly
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: SMA/SMB
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead-Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208 (3)
- Polarity: Cathode Band or Cathode Notch
- Weight: SMA 0.064 grams (Approximate)

SMB - 0.093 grams (Approximate)





Top View

Bottom View

Ordering Information(Note 4)

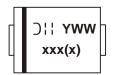
Part Number	Qualification	Case	Packaging
S1x-13-F	Commercial	SMA	5,000/Tape & Reel
S1xB-13-F	Commercial	SMB	3,000/Tape & Reel

^{*} x = Device type, e.g. S1A-13-F (SMA package); S1AB-13-F (SMB package).

Notes

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



XXX = Product Type Marking Code, ex: S1A (SMA Package)
XXXX = Product Type Marking Code, ex: S1AB (SMB Package)

J!! = Manufacturers' Code Marking
YWW = Date Code Marking
Y = Last Digit of Year (ex: 4 for 2014)
WW = Week Code (01 to 53)



Maximum Ratings(@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitance load, derate current by 20%.

Characteristic	Symbol	S1 A/AB	S1 B/BB	S1 D/DB	S1 G/GB	S1 J/JB	S1 K/KB	S1 M/MB	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	50	100	200	400	600	800	1000	V
RMS Reverse Voltage	V _{R(RMS)}	35	70	140	280	420	560	700	V
Average Rectified Output Current @ $T_T = +100$ °C	lo				1.0				Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load					30				Α

Thermal Characteristics

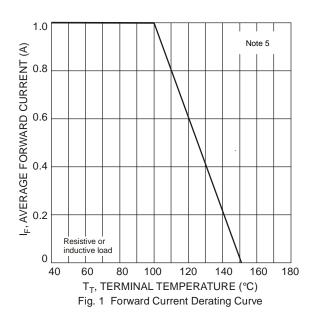
Characteristic	Symbol	Value	Unit	
Typical Thermal Resistance, Junction to Terminal (Note 5)	$R_{ heta JT}$	30	°C/W	
Operating and Storage Temperature Range	T_{J} , T_{STG}	-65 to +150	°C	

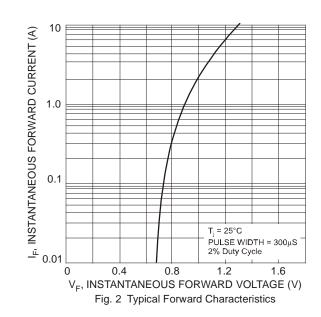
Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Min	Тур	Max	Unit
Forward Voltage	$@ I_F = 1.0A$	V _{FM}	_	_	1.1	V
Peak Reverse Leakage Current	@ T _A = +25°C		_	_	5.0	
at Rated DC Blocking Voltage	@ $T_A = +125$ °C	I _{RM}	_	_	100	μΑ
Reverse Recovery Time (Note 6)		t _{rr}	_	1.8	3.0	μs
Typical Total Capacitance (Note 7)		C _T	_	10	_	pF

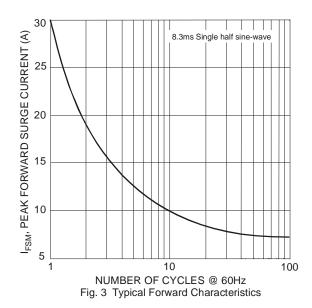
Notes:

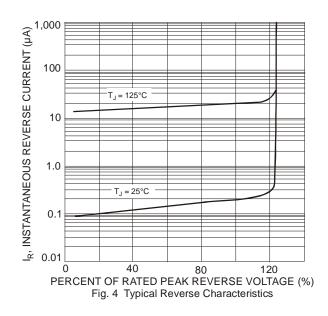
- 5. Thermal resistance junction to terminal, unit mounted on PC board with 5.0 mm² (0.013 mm thick) copper pads as heat sink.
- 6. Measured with I_F = 0.5A, I_R = 1.0A, I_{RR} = 0.25A.
- 7. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.





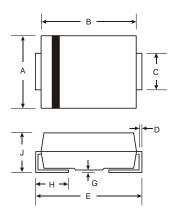




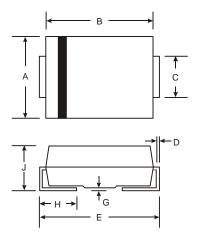


Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



SMA				
Dim	Min	Max		
Α	2.29	2.92		
В	4.00	4.60		
С	1.27	1.63		
D	0.15	0.31		
Е	4.80	5.59		
G	0.05	0.20		
Н	0.76	1.52		
J	1.96	2.40		
All Dimensions in mm				

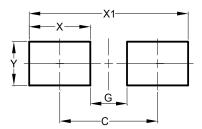


SMB				
Dim	Min	Max		
Α	3.30	3.94		
В	4.06	4.57		
С	1.96	2.21		
D	0.15	0.31		
E	5.00	5.59		
G	0.05	0.20		
Н	0.76	1.52		
J	2.00	2.50		
All Dimensions in mm				

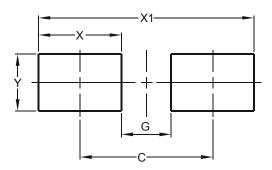


Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



S	SMA		
Dimensions Value (in mm			
С	4.00		
G	1.50		
Х	2.50		
X1	6.50		
Υ	1.70		



SMB			
Dimensions	Value (in mm)		
С	4.30		
G	1.80		
Х	2.50		
X1	6.80		
Y	2.30		



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